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PATENT
0175-0323P

TC 1700

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Scott A. Williams Conf.: 6374
Appl. No.: 09/980,589 Group: 1774
Filed: December 4, 2001 Examiner: Shewareged, Betelhem
For: IMAGE TRANSFER SHEET WITH TRANSFER
BLOCKING OVERCOAT AND HEAT TRANSFER
PROCESS USING SAME

SMALL ENTITY TRANSMITTAL FORM

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

December 4, 2003

Sir:

Transmitted herewith is a Reply to Unity of Invention Rejection in the above-identified application.


- ☒ Applicant claims small entity status under 37 C.F.R. § 1.27.
- ☐ The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.
- ☐ Petition for () month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.
- ☒ No fee is required.
- ☐ Check(s) in the amount of \$0.00 is(are) enclosed.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. A triplicate copy of this sheet is attached.

Appl. No. 09/980,589

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. §§1.16 or 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By  #42,874
Marc S. Weiner, #32,181

Craig A. McRobbie, #42,874

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Attachment(s)

(Rev. 09/30/03)



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REPLY TO UNITY OF INVENTION REJECTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

December 4, 2003

Sir:

In reply to the outstanding Unity of Invention Rejection dated November 24, 2003, the following remarks are respectfully submitted in connection with the above-identified application.

This paper includes remarks.